OPTICAL BRANCHING UNIT AND WAVEGUIDE TYPE OPTICAL COUPLER MODULE USED FOR SAME UNIT

Patent number:

JP6018744

Publication date:

1994-01-28

Inventor:

TOMITA NOBUO; others: 03

Applicant:

NIPPON TELEGR & TELEPH CORP

Classification:

- international:

G02B6/28; G01M11/00; G02B6/12

- european:

Application number:

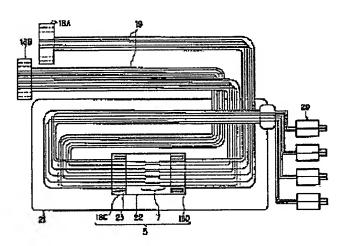
JP19930069017 19930329

Priority number(s):

Abstract of JP6018744

PURPOSE:To miniaturize an optical coupler, to simplify a surplus length processing and to simplify a production process by providing an optical coupler module formed as a chip, connecting the module with a connector and also linking the distance between connectors with an optical fiber ribbon.

CONSTITUTION: The optical branching unit is provided with a multi-core connector 18A with four cores stored used as a communication port, a multi-core connector 18B with eight cores stored used as an inspection port, multi-core connector modules 18C and 18D with eight cores stored and connected with a waveguide type optical module 22 where an optical coupler unit 7 is arranged, four-core optical fiber ribbon 19, a single-core connector 20 used as a communication port, a surplus length tray 21 and a connecting pin 23 for positioning the optical coupler module 22 and the multi-core connector modules 18C and 18D. And the waveguide type optical coupler module 22 is the chip with four integrated cores, and the multi-core connector modules 18C and 18D are connected with the module 22.



Data supplied from the esp@cenet database - Patent Abstracts of Japan

(19)日本国特許庁 (JP) (12) 公開特許公報 (A)

(11)特許出願公開番号

特開平6-18744

(43)公開日 平成6年(1994)1月28日

(51) Int.Cl. ⁵		識別記号	庁内整理番号	FI	技術表示箇所
G 0 2 B	6/28	Z	7408-2K		
G 0 1 M	11/00	U	8204-2G		
G 0 2 B	6/12	С	9018-2K		

審査請求 未請求 請求項の数6(全 12 頁)

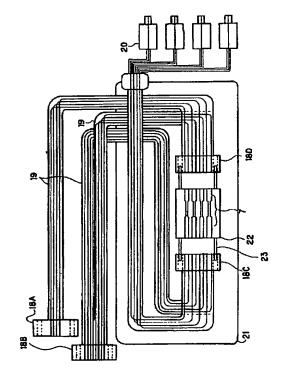
(21)出願番号	特顧平5-69017	(71)出願人	000004226
			日本電信電話株式会社
(22)出顧日	平成5年(1993)3月29日		東京都千代田区内幸町一丁目1番6号
		(72)発明者	富田 信夫
(31)優先権主張番号	特顧平4-107274		東京都千代田区内幸町一丁目1番6号 日
(32)優先日	平4 (1992) 4 月27日		本電信電話株式会社内
(33)優先権主張国	日本 (JP)	(72)発明者	山崎 功雄
(00)			東京都千代田区内幸町一丁目1番6号 日
4			本電信電話株式会社内
		(72)発明者	小山田 弥平
			東京都千代田区内幸町一丁目1番6号 日
			本電信電話株式会社内
		(74)代理人	
			最終頁に続く

(54) 【発明の名称】 光分岐ユニット及びこのユニットに用いる導波路型光カプラモジュール

(57)【要約】

【目的】 光通信分野での光回線アクセス装置に用いら れ、光線路に光挿入分岐機能を付加し、回線の試験又は モニタを可能とした光分岐ユニット及びこのユニットに 用いる導波路型光力プラモジュールを提供する。

【構成】 光分岐ユニットの光カプラ22を無調心で接 合し得るようにモジュール化すると共に、光ファイパを テープ心線19とすることにより、小型化、組立容易 化、経済化を得ることができる。



1

【特許請求の範囲】

【請求項1】 光線路試験を行なう場合に、光線路へ試 験光を挿入するための光回線アクセス装置に用いる光分 岐ユニットにおいて、

二つの2N心収容の多心コネクタモジュールに接続可能 で、N個集積してチップ化した導波路形光カプラモジュ ールを備える一方、

一方の通信ポートに当るN心収容形多心コネクタと、二 つの試験ポートに当る2N心収容形多心コネクタと、上 記一方の通信ポートに対応する他方の通信ポートに当る 10 ルに関する。 N心多心コネクタとを備え、

上記N心収容形多心コネクタと上記2N心収容形多心コ ネクタのうち一方の試験ポートに対応するN心とをテー ブ心線にて交互に収容した一方の上記2N心収容の多心 コネクタモジュールに接続し、

上記N心単心光コネクタと上記2N心収容形多心コネク タのうち他方の試験ポートに対応する残りのN心とをテ ープ心線にて交互に収容した他方の上記2N心収容の多 心コネクタモジュールに接続し、

たことを特徴とする光分岐ユニット。

【請求項2】 請求項1記載の光分岐ユニットに用いる カプラモジュールであって、

シリコン基板上に形成されたSiO』 層上に所定の間隔 を有して並設する複数の光ファイバに対応して形成され た光導波路及び該光導波路から所定の距離を有して互い に平行に形成された少なくとも2本以上の位置決め用の ガイド溝を有する光導波路基板と、

前記ガイド溝に嵌合するガイドピンを有し、複数の該ガ イドピンが前記ガイド溝内に光導波路基板の両端面から 突出させ接着固定させるガイドピン固定部材と、

前記ガイドピンが前記ガイド溝に嵌合したとき前記光導 波路に突き合わせて光結合するよう所定の位置決めされ た光ファイバを保持する多心光コネクタと、

前記光導波路と多心光コネクタとの光結合状態を保持す るクリップとを、

備えたことを特徴とする導波路型光力プラモジュール。

【請求項3】 請求項2記載の導波路型光カプラモジュ ールにおいて、前記光導波路基板の両端面における光導 波路の各軸中心とガイドピンの各軸中心との高さが一致 し、且つ同一直線上に配置されていることを特徴とする 40 導波路型光力プラモジュール。

【請求項4】 請求項2記載の導波路型光カプラモジュ ールにおいて、光導波路の上部基準面とガイドピン固定 部材との間には、空間を設けていることを特徴とする導 波路型光力プラモジュール。

【請求項5】 請求項2記載の導波路型光カプラモジュ ールにおいて、光ファイバの端面及び光導波路の光入出 射端面をそれぞれ等しい角度θで斜めに研磨しているこ とを特徴とする導波路型光力プラモジュール。

【請求項6】 請求項2記載の導波路型光カプラモジュ 50

ールにおいて、導波路型光カプラモジュールの通信線路 上には試験光除去用の光フィルタを実装したことを特徴 とする導波路型光カプラモジュール。

【発明の詳細な説明】

[0001]

【産業上の利用分野】本発明は、光通信分野での光回線 アクセス装置に用いられ、光線路に光挿入分岐機能を付 加し、回線の試験又はモニタを可能とした光分岐ユニッ ト及びこのユニットに用いる導波路型光カプラモジュー

[0002]

【従来の技術】光線路試験システムにあって従来(特開 平2-1632号)のものは、図16に示すように局内 用光ファイバケーブル9と局外用光ファイバケーブル1 0間である通信用光ファイパ11間に光分岐ユニット5 を介在させ、この光分岐ユニット5には通信ポート1, 2及び試験ポート3, 4を備え、この試験ポート3, 4 にて光挿入、光分岐を行なっている。試験ポート3,4 には試験心線選択用の1×N光スイッチ13が接続さ 20 れ、更に光ファイバ11の損失や故障点等を測定する光 パルス試験器14, 制御装置15, 試験結果の表示装置 16が備えられている。また、光伝送端局12側の光フ ァイバ11には、試験光除去用の光フィルタ17が配置 されている。

【0003】かかるシステムにあっては、試験に当りま ず、1×N光スイッチ13にてN本のうちから試験心線 を選択し、その選択した心線における光分岐ユニット5 の試験ポート3を選択する。そして、光パルス試験器1 4の試験光は、その光分岐ユニット5を介して局外用光 ファイバケープル10に挿入され、その後方散乱光のレ ベルを受光することにより、その通信用光ファイバ11 の損失・故障点位置等を測定できる。

【0004】この図16にて示される光ファイパケープ ル9,10は、数十心以上の光ファイパを収容してお り、局外ケープル10は多心形光ファイバ、局内ケープ ル9は単心形光ファイバがそれぞれ使用されている。局 外ケーブル10を成端し局内ケーブル9と接続すること は、通常MDF(主配線架)と呼ばれ、このMDFの中 に光分岐ユニットが収容されることになる。

【0005】図17は従来の光分岐ユニットの一例(実 開平2-258408号) を示したもので、図16に示 す光分岐ユニット5の通信ポート1,2及び試験ポート 3. 4に対応する通信用ポートの光ファイバ1f, 2 f. 光挿入用ポート3の光ファイバ3f, 光分岐用ポー ト4の光ファイバ4 fがそれぞれ光力プラユニット7に 個別に接続され、光ファイバ2 f はそれぞれ単心フェル ール6に接続されると共に光ファイバ1f,3f等は多 心フェルール8に接続されている光分岐ユニット5を示 している。

【0006】図18は、従来の光ファイパと光導波路と

の接続における光導波路部品の一例(特開平4-340 507号)を示したものである。同図に示すように、光 導波路部品27は光導波路31が設けられ位置決め用の ガイド28bが形成された光導波路基板28上に光導波 路31が設けられている。一方、この光導波路基板28 と突き合わせて当接され、光導波路31と接合すべき光 ファイバ11の位置決めをする光ファイバ整列滯29b と前記光導波路基板28との位置決めをするためのガイ ド29dとが形成された光ファイパ整列基板29を用 い、前記光導波路基板28と光ファイパ整列基板29と 10 の各ガイド28b,29dと嵌合して前記光導波路31 と光ファイバ11とを整合させるガイド受30cが形成 された固定基板30とを用いて光導波路部品を構成して いる。

[0007]

【発明が解決しようとする課題】ところで、上記各従来 の光分岐ユニットでは、図17にて二組の光カプラユニ ット7を構成するそれぞれの光カプラは、実際上数㎜の 円筒形部材であり、図17の如く4心とか8心のみなら ず、最近においては更に多心の分岐ユニットが形成され 20 つつあることから、装置が大形になりつつある。また、 各光カプラには光ファイパ1f,2f,3f,4fが個 別に接続されることから製造工程が多く、多心になるほ ど極めて面倒な工程が必要となる。

【0008】また、図18に示した従来の光ファイバと 光導波路との接続では、光ファイバ整列基板29の光フ ァイバ整列溝29bに光ファイパ11を収容すると同時 に光導波路基板28の光導波路31を当接しておかなけ れば固定基板30で固定ができないという問題がある。 そしてその際、光ファイバ11が長さ方向に微妙にずれ 30 るおそれがある。さらに、光ファイパ11が多心になる ほど光ファイバ整列基板29への組付けが困難になると いう問題がある。

【0009】本発明は、前記問題に鑑み、光カプラを小 型化し余長処理を小さくまとめると共に光ファイバの接 続を簡単化した光分岐ユニット及びこの光分岐ユニット に用いる導波路型光力プラモジュールを提供することを 目的とする。

[0010]

【課題を解決するための手段】上述の目的を達成する本 40 発明に係る光分岐ユニットの構成は、光線路試験を行な う場合に、光線路へ試験光を挿入するための光回線アク セス装置に用いる光分岐ユニットにおいて、二つの2 N 心収容の多心コネクタモジュールに接続可能で、N個集 積してチップ化した導波路形光カプラモジュールを備え る一方、一方の通信ポートに当るN心収容形多心コネク タと、二つの試験ポートに当る2N心収容形多心コネク タと、上記一方の通信ポートに対応する他方の通信ポー トに当るN心多心コネクタとを備え、上記N心収容形多 心コネクタと上記2N心収容形多心コネクタのうち一方 *50* 光コネクタとに嵌合した状態において、光導波路基板に

の試験ポートに対応するN心とをテープ心線にて交互に 収容した一方の上記2N心収容の多心コネクタモジュー ルに接続し、上記N心単心光コネクタと上記2N心収容 形多心コネクタのうち他方の試験ポートに対応する残り のN心とをテープ心線にて交互に収容した他方の上記2 N心収容の多心コネクタモジュールに接続したことを基 本とする。

【0011】また、本発明に係る光分岐ユニットに用い る導波路型光カプラモジュールの構成は、シリコン基板 上に形成されたSiO2層上に所定の間隔を有して並設 する複数の光ファイバに対応して形成された光導波路及 び該光導波路から所定の距離を有して互いに平行に形成 された少なくとも2本以上の位置決め用のガイド溝を有 する光導波路基板と、前記ガイド溝に嵌合するガイドピ ンを有し、複数の該ガイドピンが前記ガイド溝内に光導 波路基板の両端面から突出させ接着固定させるガイドビ ン固定部材と、前記ガイドピンが前記ガイド溝に嵌合し たとき前記光導波路に突き合わせて光結合するよう所定 の位置決めされた光ファイバを保持する多心光コネクタ と、前記光導波路と多心光コネクタとの光結合状態を保 持するクリップとを備えたことを特徴とする。

【0012】前記導波路型光カプラモジュールにおい て、光導波路基板の両端面における光導波路の各軸中心 とガイドピンの各軸中心との高さが一致し、且つ同一直 線上に配置するようにしてもよい。

【0013】前記導波路型光カプラモジュールの光導波 路基板において、光導波路の上部基準面とガイドピン固 定部材との間に、空間を設けるようにしてもよい。

【0014】前記導波路型光カプラモジュールの光導波 路基板において、光ファイパの端面及び光導波路の光入 出射端面をそれぞれ等しい角度 θ で斜めに研磨するよう にしてもよい。

【0015】導波路型光力プラモジュールの通信線路上 には、試験光除去用の光フィルタを実装するようにして もよい。

[0016]

【作用】従来の如き光力プラユニットを用いることなく チップ化した光カプラモジュールを備えてコネクタと接 綻し、しかもコネクタ間はテープ心線にてつなげること により、光カプラの小型化と余長処理が簡略化でき、ま た集積化、テープ化によって製造工程も極めて簡単とな

【0017】前記導波路型光カプラモジュールは、光導 波路基板に形成された位置決め用のガイド滯にガイドピ ンを嵌合して位置決めし且つ当該光導波路基板の両端面 より該ガイドピンを突出させ、ガイドピン固定部材によ り接着固定させる。次いで、この光導波路基板と多心光 コネクタを該光導波路基板に設けられた該ガイドピンに より嵌合させる。このガイドピンが光導波路基板と多心 設けられた光導液路と多心光コネクタに保持された多心 光コネクタとが整合され、クリップにて光結合状態が保 持される。これにより多心の光導波路と光ファイバとを 無調心で接合することが可能となる。

[0018]

【実施例】以下、図1~図15を参照して本発明の実施 例について説明する。

【0019】先づ、本発明の光分岐ユニットの実施例を 図1~図5について参照しながら説明する。

【0020】(実施例1)図1は第1実施例の光分岐ユ 10 ニットであり、18Aは通信ポートに当る4心収容の多心コネクタ、18Bは試験ポートに当る8心収容の多心コネクタ、18C、18Dは光カプラユニット7を配した導波路型光カプラモジュール22に接続される8心収容の多心コネクタモジュール、19は4心テープ心線、20は通信ポートに当る単心コネクタ、21は余長トレイ、23は光カプラモジュール22と多心コネクタモジュール18C、18Dとを位置合せするための接続用ピンである。ここにおいて、導波路型光カプラモジュール22は、4心が集積化されたチップであり、このモジュ 20 ール22に対して多心コネクタモジュール18C、18 Dが接続できるようになっている。

【0021】図2は図1に示す光カプラモジュール22とコネクタモジュール18C, 18Dとを接続して全体として光分岐ユニット5が完成した図を示している。

【0022】〔実施例2〕図3は第2実施例の光分岐ユニットであり、図1との差異は導波路型光カプラモジュール22の通信線路内に試験光除去用の光フィルタ17が挿入され、しかも通信線路に対して反射を防ぐべく適宜角度を持たせたものである。そして、この光フィルタ 3017の挿入用の穴24は、エッチング等により作られる。このフィルタ17の存在によりシステムの簡易化や経済化を図ることができる。

【0023】〔実施例3〕図4は第3実施例の光分岐ユニットであり、導波路型光カプラモジュール22に備えられるフィルタ基板25には通信線路の配列に合わせて光フィルタ17が備えられる。しかも、図3の場合と同様通信線路に対して反射を防ぐため適切な角度を持たせた溝26に嵌められ接着剤で固定される。フィルタ基板25及びフィルタ17は図5(a)(b)に示すようにのよざく形状にあるいは橋げた形状となるように構成され得る。この場合、図3に示す構造と比較してエッチングによらず通常の切削加工ができ、導波路型光カプラモジュール22の作成が容易になった。

[0024] 上述した光分岐ユニットにおいては、光力プラモジュールの内部についての説明を省いているが、この光カプラとしては光分岐ができればよく、以下に示す実施例に限定されず、種々の構造が考えられる。

【0025】次に、本発明の光分岐ユニットに用いて好の位置に、且つガイドピン23の軸中心の深さが前配光 適な導波路型光カプラモジュールの実施例について図650 導波路31の深さと一致するよう設定し形成され、後に

~図15を参照しながら説明する。

【0026】〔実施例4〕図6は、本発明の第4実施例であり、導波路型光カプラモジュール22は、光導波路基板32と、ガイドピン固定部材33と、多心光コネクタ(8MT)18と、クリップ34と、ガイドピン23とにより構成されており、光導波路と光ファイバとの接合状態を示した図である。

【0027】図7は、図6の分解図であり、光導波路基板32には、光導波路31と位置決め用ガイド溝36とが設けられ、該ガイド溝36にガイドピン23を嵌合して位置決めし且つ光導波路基板32の両端面からガイドピン23の一部を突出させた状態でガイドピン固定部材33により接着剤35にて接着固定され、該ガイドピン23は光導波路基板32に保持される。多心光コネクタ(8MT)18は、前配ガイドピン23が前配ガイド溝36に嵌合したとき前配光導波路31に突き合わせて光結合するよう所定の位置決めされた光ファイバ11を保持しており、該多心光コネクタ(8MT)18のガイドピン穴37に突き合わされることにより、接合が可能となる。クリップ34は、前配光導波路31と多心光コネクタ(8MT)18との光結合状態を保持するものである。

【0028】図8は、図7に示した多心光コネクタ(8 MT)18の一部破断斜視図であり、通信ポート及び試験ポートに当たる2つの4心テープ心線19を多心光コネクタのフェルールに挿入したものである。ここで2つの4心テープ心線19,19のそれぞれの心線は、交互に収容され対向する導波路型光カプラモジュール22と接続される。

【0029】図9は、光導波路31とガイドピン23の相対位置関係を示す端面図であり、光導波路基板32は、シリコン基板上に形成されたSiOz層上に所定の間隔を有して並設する複数の光ファイバ11に対応して形成された光導波路31及び該光導波路31から所定の距離Wを有して互いに平行に形成された少なくとも2本以上の位置決め用のガイド溝36を設けている。また、ガイドピン固定部材33は、前記ガイド溝36に嵌合するガイドピン23を固定するもので、複数の該ガイドピン23が前記ガイド溝36内光導波路基板32の両端面から突出させた状態で接着固定している。

【0030】光導波路基板32の端面において光導波路基板32に形成された光導波路31は複数本、例えば本実施例では、8本の光導波路31が設けられている。これらの光導波路31は、図9に示すように、各軸中心が光導波路基板32の上面を基準とする基準面38から所定の深されの位置に、且つ各軸中心距離が所定の間隔P、で並んで設けられている。また、位置決め用のガイド滯36は両端の光導波路31の軸中心から所定の距離Wの位置に、且つガイドピン23の軸中心の深さが前記光速波路31の深さと一致するよう設定し形成され、後に

接続されるガイドピン23と嵌合するガイドピン穴37を有する多心光コネクタ(8MT)18が保持する複数の光ファイパ11の夫々の間隔P: 及びガイドピン穴37の間隔P: との相対位置を夫々合致させて同一直線上に配置される。

【0031】一方、ガイドピン固定部材33は、光導液路基板32と対向する下面33aが凹部を形成しており、深さdと光導波路基板32の基準面38からガイドピン23の頂点の高さhiとが等しく(d=hi)設定されている。そしてガイドピン23は光導波路基板32 10のガイド溝36の周面とガイドピン固定部材33の下面33aとにより挟持され、固定される。そして、光導波路基板32の両端面と光導波路31の各両端面とガイドピン固定部材33の両端面は光率波路31の各両端面とガイドピン固定部材33の両端面は夫々面一とされている。

[0032] 図10は、図9におけるガイドピン23をガイド溝36に挟持し接着固定したものであり、ガイド溝36のガイドピン23の下面側の空間内及びガイドピン固定部材33と光導波路基板32との当接側の空間内のみ接着剤35を充填して接着固定しており、光導波路31の上部基準面38とガイドピン固定部材33との間20には、光導波路31に影響を与えないために接着剤35の充填を避け、空間を形成している。

【0033】光導波路基板32、ガイドピン固定部材33等は、基板材料として例えば、単結晶シリコンを用い、位置決め用ガイド灣36等をシリコンの異方性エッチング技術によりV滯形成することが可能である。また、シリコン基板上に容易に構成可能な火災堆積法による石英導波路を用いることができ高精度に形成される。

【0034】図10に示した光導波路基板32の光導波路31と多心光コネクタ(8MT)18の光ファイバ1 301とがガイドピン23により正確に整合し、且つ各整合端面同志が当接される。これにより光導波路31と光ファイバ11とは無調心で正確に接合される。

[0035] (実施例5) 図11は、本発明の第5の実施例であり、導波路型光カプラモジュール22の接合部の斜視図を示し、図12は導波路型光カプラモジュール22の側面図を示す図である。

【0036】図11、図12において前配第4の実施例の図6~図10において説明したものと同時の部分については同一符号を付し、且つ同等部分の説明は省略す 40 る。

【0037】第5の実施例に係る導波路型光カプラモジュールは、図11、12に示すように、光導波路31と多心光コネクタ(8MT)18の光ファイバ11とがガイドピン23により整合される際、当接される多心光コネクタ(8MT)18の光ファイバ11の露出する多心光コネクタ18の端面18a及び光導波路31の光入出射端面22aとがそれぞれ等しい角度ので斜めに研磨されたものである。第5の実施例は、前配第4の実施例の光導波路31と多心光コネクタ(8MT)18の光ファ 50

8

イバ11との接合部分で生じるフレネル反射による反射 戻り光を低減するためのものである。例えば、光ファイ パの11の露出する多心光コネクタ18の端面18a及 び光導波路31の光入出射端面22aを約8度以上の角 度 θ で高精度な角度研磨を行うことにより、フレネル反 射による反射光が導波モードになるのを防ぎ、またフレ ネル反射による伝搬光の接続損失の低減が図れる。

【0038】〔実施例6〕図13は、本発明の第6の実施例であり光導波路基板32とガイドピン固定部材33 との関係を示す端面図を示し、図14は図13の嵌合状態を示す図である。

[0039]第6の実施例に係る導波路型光カプラモジュールは、図13,14に示すように、ガイドピン固定部材33は光導波路基板32の上面及び両側面を囲うようにその断面形状が逆凹状に形成され、ガイドピン23は、前記第4の実施例と同様に挟持される。

【0040】第6の実施例では、図13に示すように、 光入出射端面22aの大きさに制限を加えているため、 光導波路基板32の両側面32a,32bをガイド溝3 6の手前まで削っており、側面32aから32b間の幅 D1に対抗するようガイドピン固定部材33の下面33 aが等しく(D=D1)設定される。また、光導波路基板32と対抗する下面33aが凹条とされた深さH1と 光導波路基板32の下面32cからガイドピン23の頂点の高さHとが等しく(H=H1)設定され、ガイドピン23が光導波路基板32のガイド溝36の周面とガイドピン固定部材33の下面33aとにより挟持され、光 導波路基板32の両側面32a,32bに接着剤35により接着固定される。

【0041】第6の実施例は、前記第4の実施例のガイドピン23の固定において、より強度のあるガイドピン23の固定ができる。また、光導波路基板32とガイドピン固定部材33との接着においても、より強度な接着固定が可能となり、ガイドピン23のガイド溝36に対する脱着も可能となる優れた効果がある。

【0042】〔実施例7〕図15は、第7の実施例であり本発明の光分岐ユニットの試作構成を示す図である。

【0043】第7の実施例は、図15に示すように光分岐ユニットを試作したものであり、光分岐ユニットの簡素化が図れた。同図に示すように、余長処理部を波線で表しており、テーブ化による複雑さが無いのが確認される。また、導波路型光カプラモジュール22をユニット内に横向きに立てて実装することによりテープ心線19の余長処理部でのねじれやひずみがなくテーブ心線19の組付けができる。

【0044】試作品の測定結果を「表1」に示す。本試作においての導波路型光カプラモジュール22については、直線導波路型光モジュールを用いて行った結果である。

50 [0045]

【表1】

測定結果一覧表

9

心	線 Na	# 1	# 2	# 3	# 4	# 5	# 6	# 7	# 8
接続損失(dB)		0. 69	0.87	0. 72	0.77	0. 61	0.60	0. 57	0. 80
反射減衰量(dB)		49	46	52	47	51	47	52	47
温度	MAX値(dB)	0. 16	0. 13	0.10	0. 15	0. 07	0. 04	0.05	0.06
サイクル	MIN値(dB)	-0.14	-0. 05	-0. 07	-0.16	-0.03	-0. 02	-0.04	-0.03
特性	変動量(dB)	0. 30	0. 18	0. 17	0.31	0. 10	0. 06	0.09	0.09
偏光Loss特性(dB)		0.09	0.11	0. 14	0.12	0.10	0. 05	0.10	0.07

【0046】上記第4~第6の実施例では、光導波路基 板32に位置決め用のガイド溝36を一体に形成したガ イドピン方式の場合を示したが、本発明はこれに限るも 20 のではなく、例えば他の形状や光導波路と位置決め用の ガイド溝とを各別に形成し、それぞれ所定の位置関係で 正確に固定してもよい。また、上記実施例において8本 の光導波路31を形成した場合を示したが、本発明はこ れに限るものではなく、多数の光導波路と光ファイバと を接合する場合を用いても本発明の効果を得ることがで きる。また、この光カプラとしては光分岐ができればよ く種々の構造が考えられる。

[0047]

【発明の効果】以上説明したように本発明では、集積化 30 である。 チップ化及びテープ化を図ることにより、構成の簡素 化、組立の簡易化が図れるので、光線路における光アク セス部分を小型で経済的なものが得られる。また、本発 明の導波路型光カプラモジュールによれば、光導波路と 光ファイパとを無調心で且つ極めて容易に光結合させる ことが可能となり、光導波路と光ファイパとの接続を多 心一括で行うことが可能となり、作業能率が大幅に向上 し、コストの低減が図られる。また、ガイドピン及びク リップによる接続のため、光導波路と光ファイパの脱着 が可能となり、光導波路チップ等の取り換えが容易にで 40 き、且つ接続部の伝送損失を小さくすることができるな ど、各部品の構成が簡単であるという優れた効果があ る.

【図面の簡単な説明】

- 【図1】本発明の第1の実施例を示す構成図である。
- 【図2】図1の結合完了を示す構成図である。
- 【図3】本発明の第2の実施例を示す構成図である。
- 【図4】本発明の第3の実施例を示す構成図である。
- 【図5】本発明の第3の実施例におけるフィルタ基板と 光フィルタとを示す斜視図である。

【図 6】 本発明の第4の実施例を示す組立斜視図であ

【図7】図6の分解斜視図である。

【図8】多心コネクタモジュール18C,18Dの一部 破断斜視図である。

【図9】光導波路基板とガイドピン固定部材との関係を 示す端面図である。

【図10】光導波路基板とガイドピン固定部材との嵌合 状態を示す図である。

【図11】本発明の第5の実施例を示す組立斜視図であ

【図12】光導波路と光ファイバとの接合状態を示す図

【図13】本発明の第6の実施例を示す端面図である。

【図14】光導波路基板とガイドピン固定部材との嵌合 状態を示す図である。

【図15】本発明の第7の実施例を示す試作構成図であ

【図16】光線路試験システムの構成図である。

【図17】従来の光分岐ユニットを示す構成図である。

【図18】従来の光導波路と光ファイバとの接合を示す 組立斜視図である。

【符号の説明】

- 1, 2 通信ポート
- 3. 4 試験ポート
- 5 光分岐ユニット
- 6 単心フェルール
- 7 光カプラユニット
- 8 多心フェルール
- 9 局内ケーブル
- 10 局外ケーブル
- 11 光ファイバ
- 50 12 光伝送端局

特開平6-18744 12

11

- 13 1×N光スイッチ
- 14 光パルス試験器
- 15 制御装置
- 16 表示装置
- 17 光フィルタ
- 18 多心光コネクタ
- 19 テープ心線
- 20 単心コネクタ
- 21 余長トレイ
- 22 導波路型光カプラモジュール
- 23 ガイドピン
- 24 光フィルタ挿入用の穴
- 25 フィルタ基板

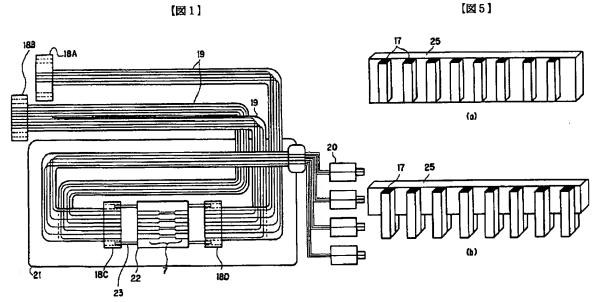
26 フィルタ基板挿入溝

- 27 光導波路部品
- 28 光導波路基板
- 29 光ファイパ整列基板
- 30 固定基板
- 31 光導波路
- 32 光導波路基板
- 33 ガイドピン固定部材
- 34 クリップ
- 10 35 接着剤

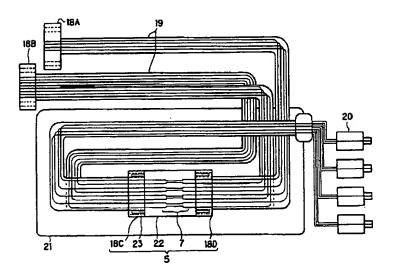
(7)

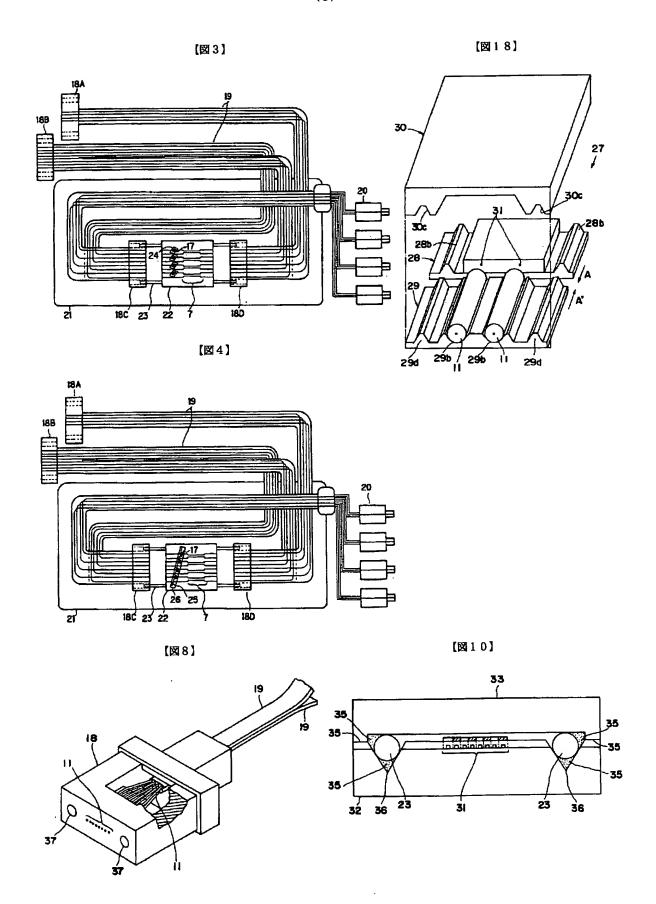
- 36 ガイド湾
- 37 ガイドピン穴
- 38 基準面

【図1】

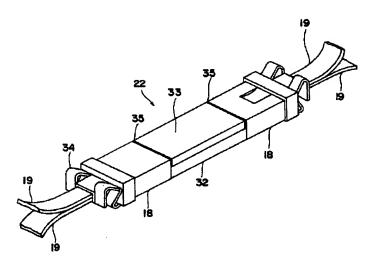




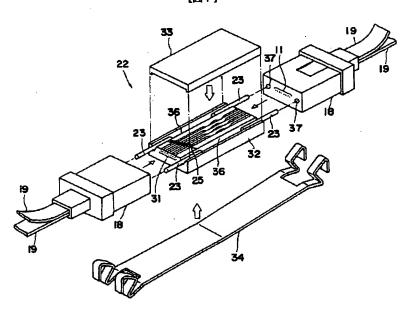




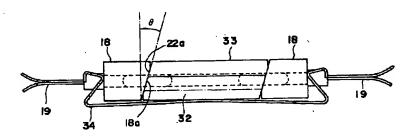
【図6】

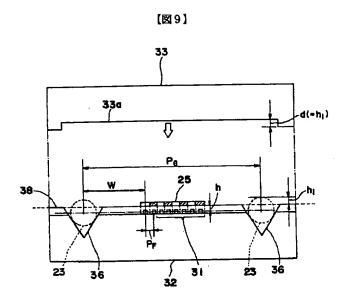


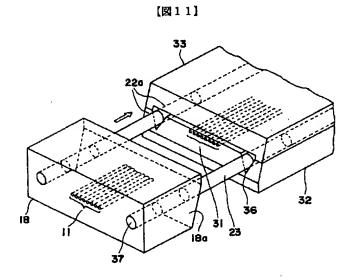
[図7]

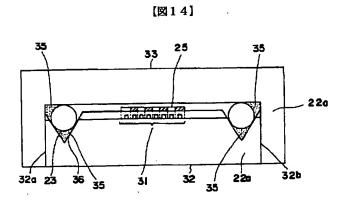


【図12】

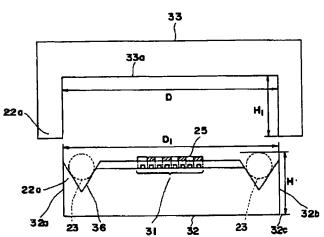




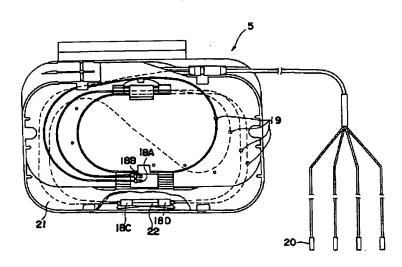




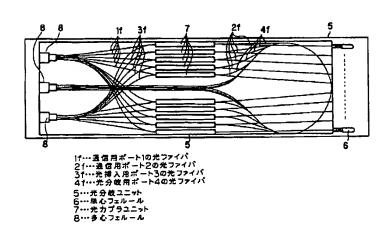




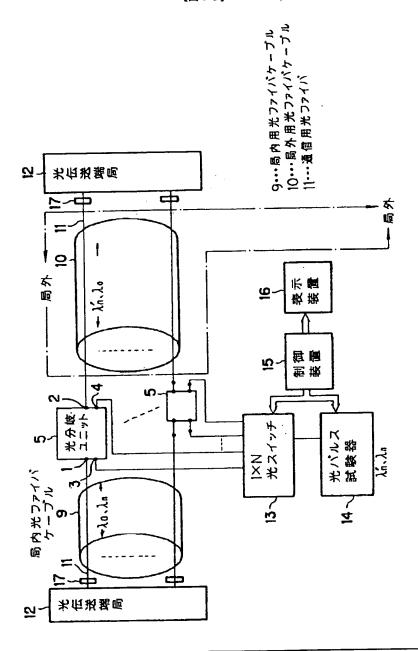
【図15】



【図17】



【図16】



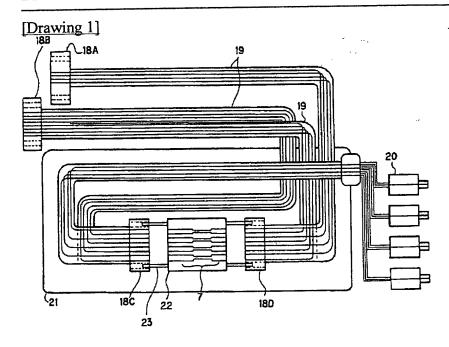
フロントページの続き

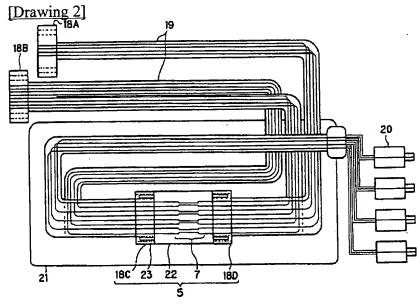
(72)発明者 千田 和憲 東京都千代田区内幸町一丁目1番6号 日 本電信電話株式会社内

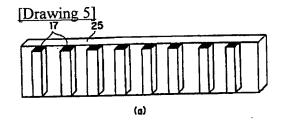
JPO and NCIPI are not responsible for any damages caused by the use of this translation.

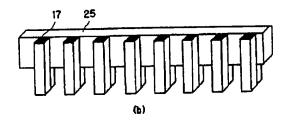
- 1. This document has been translated by computer. So the translation may not reflect the original precisely.
- 2.**** shows the word which can not be translated.
- 3.In the drawings, any words are not translated.

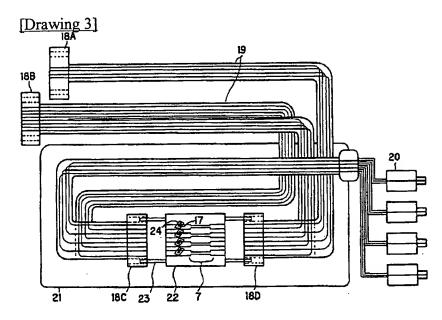
DRAWINGS



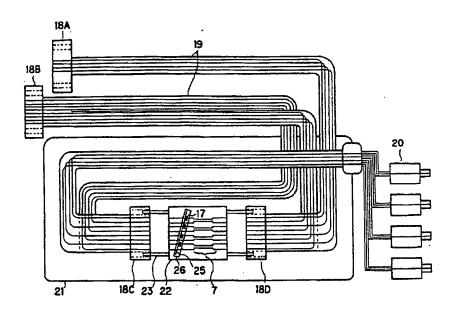


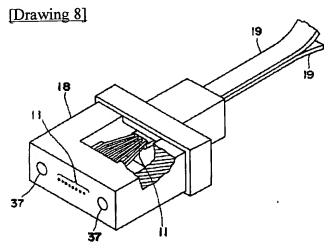


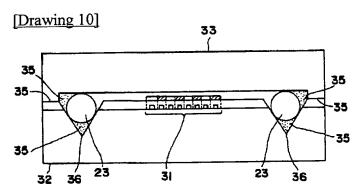




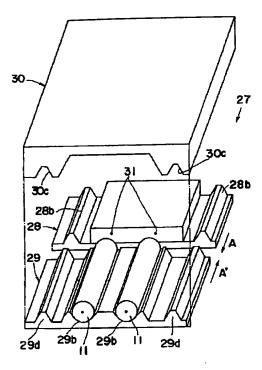
[Drawing 4]

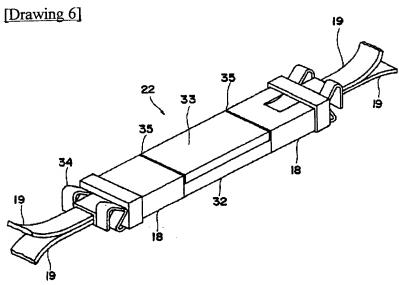




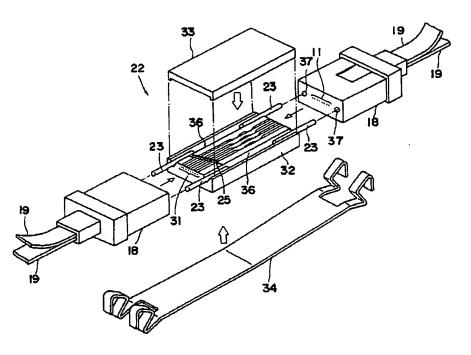


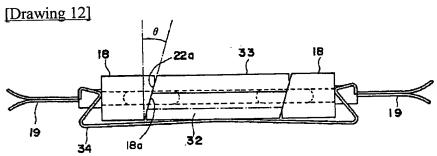
[Drawing 18]

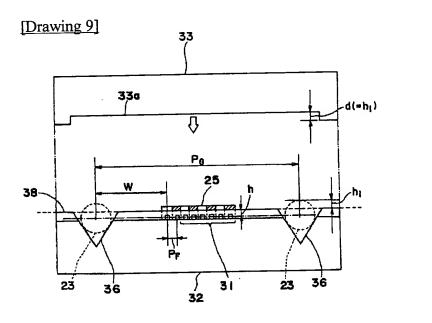




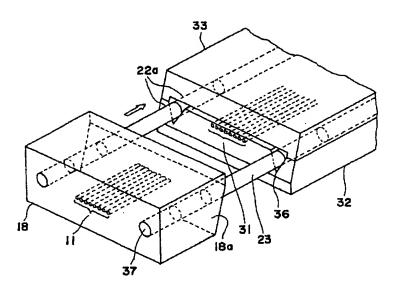
[Drawing 7]

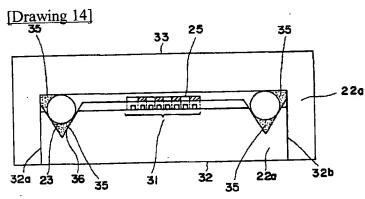


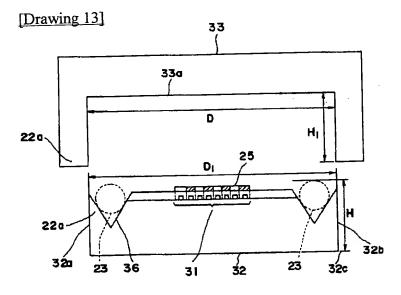




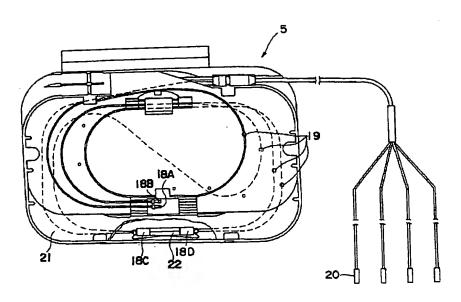
[Drawing 11]

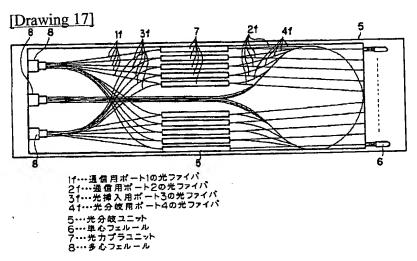




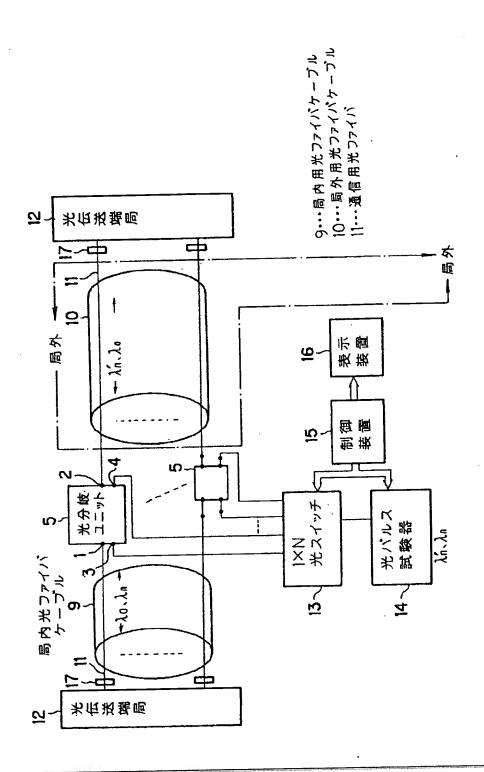


[Drawing 15]





[Drawing 16]



JPO and NCIPI are not responsible for any damages caused by the use of this translation.

- 1. This document has been translated by computer. So the translation may not reflect the original precisely.
- 2.**** shows the word which can not be translated.
- 3.In the drawings, any words are not translated.

DESCRIPTION OF DRAWINGS

[Brief Description of the Drawings]

[Drawing 1] It is the block diagram showing the 1st example of this invention.

[Drawing 2] It is the block diagram showing the completion of joint of drawing 1.

[Drawing 3] It is the block diagram showing the 2nd example of this invention.

[Drawing 4] It is the block diagram showing the 3rd example of this invention.

[Drawing 5] It is the perspective view showing the 3rd filter base plate and optical filter in an example of this invention.

[Drawing 6] It is the assembly perspective view showing the 4th example of this invention.

[Drawing 7] It is the decomposition perspective view of drawing 6.

[Drawing 8] some multi-core connector modules 18C and 18D -- it is a fracture perspective view.

[Drawing 9] It is the end view showing the relation between an optical waveguide substrate and a guide pin holddown member.

[Drawing 10] It is drawing showing the fitting condition of an optical waveguide substrate and a guide pin holddown member.

[Drawing 11] It is the assembly perspective view showing the 5th example of this invention.

[Drawing 12] It is drawing showing the junction condition of optical waveguide and an optical fiber.

[Drawing 13] It is the end view showing the 6th example of this invention.

[Drawing 14] It is drawing showing the fitting condition of an optical waveguide substrate and a guide pin holddown member.

[Drawing 15] It is the prototype block diagram showing the 7th example of this invention.

[Drawing 16] It is a beam-of-light way trial structure-of-a-system Fig.

[Drawing 17] It is the block diagram showing the conventional optical branching unit.

[Drawing 18] It is the assembly perspective view showing junction to the conventional optical waveguide and an optical fiber.

[Description of Notations]

1 Two Communication link port

3 Four Trial port

5 Optical Branching Unit

6 Single Alignment Ferrule 7 Optical Coupler Unit

8 Multi-core Ferrule

9 Office Cable

10 Outside Cable

- 11 Optical Fiber
- 12 Optical Transmission Terminal Office
- 13 1XN Optical Switch
- 14 Light Pulse Tester
- 15 Control Unit
- 16 Display
- 17 Optical Filter
- 18 Multi-core Photoconnector
- 19 Tape Core Wire
- 20 Single Alignment Connector
- 21 Extra Length Tray
- 22 Waveguide Type Light Coupler Module
- 23 Guide Pin
- 24 Hole for Optical Filter Insertion
- 25 Filter Base Plate
- 26 Filter Base Plate Insertion Slot
- 27 Optical Waveguide Components
- 28 Optical Waveguide Substrate
- 29 Optical Fiber Alignment Substrate
- 30 Fixed Substrate
- 31 Optical Waveguide
- 32 Optical Waveguide Substrate
- 33 Guide Pin Holddown Member
- 34 Clip
- 35 Adhesives
- 36 Guide Slot
- 37 Guide Pin Hole
- 38 Datum Level

JPO and NCIPI are not responsible for any damages caused by the use of this translation.

- 1. This document has been translated by computer. So the translation may not reflect the original precisely.
- 2.**** shows the word which can not be translated.
- 3.In the drawings, any words are not translated.

DETAILED DESCRIPTION

[Detailed Description of the Invention]

[0001]

[Industrial Application] This invention is used for the optical line access equipment in the optical-communication field, adds an optical insertion branching function to a beam-of-light way, and relates to the waveguide type light coupler module used for the optical branching unit which made a trial or monitor of a circuit possible, and this unit.

[0002] [Description of the Prior Art] Being in a beam-of-light way trial system, the thing of the former (JP,2-1632,A) makes the optical branching unit 5 intervene between the optical fibers 11 for a communication link which they are between the fiber optic cable 9 for offices, and the fiber optic cable 10 for the outsides, as shown in drawing 16, equips this optical branching unit 5 with the communication link ports 1 and 2 and the trial ports 3 and 4, and is performing optical insertion and optical branching in these trial ports 3 and 4. The 1xN optical switch 13 for trial core-wire selection is connected to the trial ports 3 and 4, and it has the light pulse tester 14 which measures loss, the fault point, etc. of an optical fiber 11 further, the control unit 15, and the display 16 of a test result. Moreover, the optical filter 17 for trial light removal is arranged at the optical fiber 11 by the side of the optical transmission terminal office 12.

[0003] If it is in this system, in a trial, first, blank test core wire is chosen among N books with the 1xN optical switch 13, and the trial port 3 of the optical branching unit 5 in the selected core wire is chosen. And the trial light of the light pulse tester 14 is inserted in the fiber optic cable 10 for the outsides through the optical branching unit 5, and can measure loss, the fault point location, etc. of the optical fiber 11 for a communication link by receiving the level of the back scattered light.

[0004] The fiber optic cables 9 and 10 shown by this drawing 16 have held the optical fiber of dozens of or more alignments, as for the outside cable 10, a multi-core form optical fiber is used, and, as for the office cable 9, the single alignment type optical fiber is used, respectively. It will usually be called MDF (the main wiring rack) to carry out termination of the outside cable 10, and to connect with an office cable 9, and an optical branching unit will be held into this MDF. [0005] Drawing 17 is what showed an example (JP,2-258408,U) of the conventional optical branching unit. The optical fibers 1f and 2f of the port for a communication link corresponding to the communication link ports 1 and 2 and the trial ports 3 and 4 of the optical branching unit 5 which are shown in drawing 16, 3f of optical fibers of the port 3 for optical insertion, and 4f of optical fibers of the port 4 for optical branching are connected to the optical coupler unit 7 according to an individual, respectively. While 2f of optical fibers is connected to the single alignment ferrule 6, respectively, optical fibers 1f and 3f etc. show the optical branching unit 5

connected to the multi-core ferrule 8.

[0006] Drawing 18 shows an example (JP,4-340507,A) of the optical waveguide components in connection between the conventional optical fiber and optical waveguide. As shown in this drawing, as for the optical waveguide components 27, optical waveguide 31 is formed on the optical waveguide substrate 28 with which optical waveguide 31 was formed and guide 28b for positioning was formed. On the other hand, compare with this optical waveguide substrate 28, and it is contacted and the optical fiber alignment substrate 29 with which guide 29d for carrying out positioning with optical fiber alignment slot 29b which positions the optical fiber 11 which should be joined to optical waveguide 31, and said optical waveguide substrate 28 was formed is used. Optical waveguide components are constituted using the fixed substrate 30 with which guide carrier 30c which it fits in [c] with each guides 28b and 29d of said optical waveguide substrate 28 and the optical fiber alignment substrate 29, and adjusts said optical waveguide 31 and optical fiber 11 was formed.

[0007]

[Problem(s) to be Solved by the Invention] by the way, in the optical branching unit since each above-mentioned **, each optical coupler which constitutes 2 sets of optical coupler units 7 from drawing 17 is a several mm cylindrical shape member in practice, and since the branching unit of further multi-core is formed not only in four alignments or eight alignments but in recently like drawing 17, equipment is becoming large-sized. Moreover, since optical fibers 1f, 2f, 3f, and 4f are connected to each optical coupler according to an individual, there are many production processes, and such a very troublesome process is needed that it becomes multi-core. [0008] Moreover, in connection with the conventional optical fiber and optical waveguide which were shown in drawing 18, if the optical waveguide 31 of the optical waveguide substrate 28 is not contacted at the same time it holds an optical fiber 11 in optical fiber alignment slot 29b of the optical fiber alignment substrate 29, there is a problem that immobilization is impossible with the fixed substrate 30. And there is a possibility that an optical fiber 11 may shift in the dielength direction delicately, in that case. Furthermore, there is a problem that attachment by the optical fiber alignment substrate 29 becomes difficulty, so that an optical fiber 11 becomes multi-core.

[0009] This invention aims at offering the waveguide type light coupler module used for the optical branching unit which simplified connection of an optical fiber, and this optical branching unit while it miniaturizes an optical coupler and summarizes extra length processing small in view of said problem.

[0010]

[Means for Solving the Problem] The configuration of the optical branching unit concerning this invention which attains the above-mentioned purpose When performing a beam-of-light way trial, it can connect with the multi-core connector module of two 2-N alignment hold in the optical branching unit used for the optical line access equipment for inserting trial light in a beam-of-light way. N alignment hold form multi-core connector which hits one communication link port while it has the chip-ized waveguide form light coupler module which carried out N individual accumulation, It has 2-N alignment hold form multi-core connector which hits two trial ports, and N alignment multi-core connector which hits the communication link port of another side corresponding to above-mentioned one communication link port. While held N alignment corresponding to one trial port by turns with tape core wire among the above-mentioned N alignment hold form multi-core connector and the above-mentioned 2-N alignment hold form multi-core connector module of the above-mentioned 2-N alignment hold. It is based on having connected the remaining N alignment corresponding to the trial port of another side to the multi-core connector module of

the above-mentioned 2-N alignment hold of another side held by turns with tape core wire among the above-mentioned N ****** optical connecter and the above-mentioned 2-N alignment hold form multi-core connector.

[0011] Moreover, the configuration of the waveguide type light coupler module used for the optical branching unit concerning this invention SiO2 formed on the silicon substrate The optical waveguide substrate which has the guide slot for positioning of at least two or more which has a predetermined distance and was formed in parallel from the optical waveguide and this optical waveguide which were formed corresponding to two or more optical fibers which have and install predetermined spacing on a layer, The guide pin holddown member which have [holddown member] the guide pin which fits into said guide slot, and these two or more guide pins make said guide Mizouchi project [holddown member] from the both-ends side of an optical waveguide substrate, and carries out adhesion immobilization, It is characterized by having a clip holding the optical coupling condition of the multi-core photoconnector which holds the optical fiber by which the position arrangement was carried out to comparing and carrying out optical coupling to said optical waveguide when said guide pin fits into said guide slot, and said optical waveguide and multi-core photoconnector.

[0012] The height of the each shaft center of optical waveguide and each shaft center of a guide pin in the both-ends side of an optical waveguide substrate is in agreement, and you may make it arrange on the same straight line in said waveguide type light coupler module.

[0013] You may make it prepare space between the up datum level of optical waveguide, and a guide pin holddown member in the optical waveguide substrate of said waveguide type light coupler module.

[0014] You may make it grind aslant the end face of an optical fiber, and the optical ON outgoing radiation end face of optical waveguide at the respectively equal include angle theta in the optical waveguide substrate of said waveguide type light coupler module.

[0015] On the communication line of a waveguide type light coupler module, it may be made to mount the optical filter for trial light removal.

[0016]

[Function] Moreover, a miniaturization and extra length processing of an optical coupler could be simplified by tying with tape core wire between connectors by having the chip-ized optical coupler module and connecting with a connector, without using the conventional ****** coupler unit, and the production process also became very easy by integration and tape-ization. [0017] Said waveguide type light coupler module fits in and positions a guide pin into the guide slot for positioning formed in the optical waveguide substrate, and makes this guide pin project from the both-ends side of the optical waveguide substrate concerned, and carries out adhesion immobilization by the guide pin holddown member. Subsequently, fitting is carried out with this guide pin in which this optical waveguide substrate and multi-core photoconnector were formed by this optical waveguide substrate. The optical waveguide by which this guide pin was prepared in the optical waveguide substrate in the condition of having fitted into the optical waveguide substrate and the multi-core photoconnector, and the multi-core photoconnector held at the multi-core photoconnector are adjusted, and an optical coupling condition is held with a clip. It enables this to join multi-core optical waveguide and optical fiber by no aligning.

[0018] [Example] Hereafter, the example of this invention is explained with reference to drawing 1 drawing 15.

[0019] It explains referring to the example of point ** and the optical branching unit of this invention about drawing 1 - drawing 5.

[0020] [Example 1] The multi-core connector of 4 alignment hold to which drawing 1 is the

optical branching unit of the 1st example, and 18A hits a communication link port, The multi-core connector of 8 alignment hold to which 18B hits a trial port, the multi-core connector module of 8 alignment hold connected to the waveguide type light coupler module 22 with which 18C and 18D allotted the optical coupler unit 7, It is a pin for connection for the single alignment connector to which 19 hits 4 alignment tape core wire, and 20 hits a communication link port, and 21 to align an extra length tray, and for 23 align the optical coupler module 22 and the multi-core connector modules 18C and 18D. In here, the waveguide type light coupler module 22 is the chip by which four alignments were integrated, and can connect now the multi-core connector modules 18C and 18D to this module 22.

[0021] <u>Drawing 2</u> shows drawing which connected the optical coupler module 22 and the connector modules 18C and 18D which are shown in <u>drawing 1</u>, and the optical branching unit 5 completed as a whole.

[0022] [Example 2] <u>Drawing 3</u> is the optical branching unit of the 2nd example, and it gives an include angle suitably so that the optical filter 17 for trial light removal may be inserted into the communication line of the waveguide type light coupler module 22 and the difference with <u>drawing 1</u> may moreover prevent reflection to the communication line. And the hole 24 for insertion of this optical filter 17 is made by etching etc. Simplification and economization of a system can be attained by existence of this filter 17.

[0023] [Example 3] Drawing 4 is the optical branching unit of the 3rd example, and the filter base plate 25 with which the waveguide type light coupler module 22 is equipped is equipped with an optical filter 17 according to the array of the communication line. And in order to prevent reflection to the communication line like the case of drawing 3, it is inserted in the slot 26 which gave the suitable include angle, and is fixed with adhesives. the filter base plate 25 and a filter 17 are shown in drawing 5 (a) and (b) -- as -- the shape of a ***** rectangle -- or it may be constituted so that it may become a bridge beam configuration. In this case, as compared with the structure shown in drawing 3, it was not based on etching, but the usual cutting was completed, and creation of the waveguide type light coupler module 22 became easy. [0024] In the optical branching unit mentioned above, although the explanation about the interior of an optical coupler module is omitted, it is not limited to the example shown below that optical branching is just performed as this optical coupler, but various structures can be considered. [0025] Next, it explains, using for the optical branching unit of this invention, and referring to drawing 6 - drawing 15 about the example of a suitable waveguide type light coupler module. [0026] [Example 4] Drawing 6 is the 4th example of this invention, and the waveguide type light coupler module 22 is constituted by the optical waveguide substrate 32, the guide pin holddown member 33, the multi-core photoconnector (8MT) 18, the clip 34, and the guide pin 23, and is drawing having shown the junction condition of optical waveguide and an optical fiber. [0027] Drawing 7 is the exploded view of drawing 6, where optical waveguide 31 and the guide slot 36 for positioning were established in the optical waveguide substrate 32, and it fitted in and positioned the guide pin 23 to it in this guide slot 36 and some guide pins 23 are made to project from the both-ends side of the optical waveguide substrate 32, adhesion immobilization is carried out by the guide pin holddown member 33 with adhesives 35, and this guide pin 23 is held at the optical waveguide substrate 32. The multi-core photoconnector (8MT) 18 holds the optical fiber 11 by which the position arrangement was carried out to comparing and carrying out optical coupling to said optical waveguide 31, when said guide pin 23 fits into said guide slot 36, and it becomes joinable by being compared in the guide pin hole 37 of this multi-core photoconnector (8MT) 18. A clip 34 holds the optical coupling condition of said optical waveguide 31 and multi-core photoconnector (8MT) 18. [0028] The multi-core photoconnector (8MT) 18 shown in drawing 7 is a fracture perspective

view a part, and <u>drawing 8</u> inserts in the ferrule of a multi-core photoconnector two 4 alignment tape core wire 19 which hits a communication link port and a trial port. Each core wire of two 4 alignment tape core wire 19 and 19 is connected with the waveguide type light coupler module 22 which is held by turns and counters here.

[0029] It is SiO2 by which drawing 9 is the end view showing the relative-position relation between optical waveguide 31 and a guide pin 23, and the optical waveguide substrate 32 was formed on the silicon substrate. The guide slot 36 for positioning of at least two or more which has the predetermined distance W and was formed in parallel from the optical waveguide 31 and this optical waveguide 31 which were formed corresponding to two or more optical fibers 11 which have and install predetermined spacing on a layer is formed. Moreover, the guide pin holddown member 33 fixes the guide pin 23 which fits into said guide slot 36, and after these two or more guide pins 23 have made it project from the both-ends side of said guide slot 36 intrinsic-light waveguide substrate 32, it is carrying out adhesion immobilization. [0030] As for the optical waveguide 31 formed in the optical waveguide substrate 32 in the end face of the optical waveguide substrate 32, eight optical waveguides 31 are formed by two or more, for example, this example. the location of depth h predetermined [the datum level / shaft center / each / 38 on the basis of the top face of the optical waveguide substrate 32 as such optical waveguides 31 are shown in drawing 9 to] -- and spacing PF predetermined in each shaft center distance It is prepared side by side. The guide slot 36 for positioning in moreover, the location of the predetermined distance W from the shaft center of the optical waveguide 31 of both ends And it is set up and formed so that the depth of the shaft center of a guide pin 23 may be in agreement with the depth of said optical waveguide 31. Each spacing PF of two or more optical fibers 11 which the guide pin 23 connected behind and the multi-core photoconnector (8MT) 18 which has the guide pin hole 37 which fits in hold And spacing PG of the guide pin hole 37 A relative position is made to agree, respectively and it is arranged on the same straight

[0031] On the other hand, the optical waveguide substrate 32 and inferior-surface-of-tongue 33a which counters form the crevice, and the guide pin holddown member 33 is the height h1 of the top-most vertices of a guide pin 23 from the datum level 38 of depth d and the optical waveguide substrate 32. It is set up equally (d=h1). And a guide pin 23 is pinched by the peripheral surface of the guide slot 36 of the optical waveguide substrate 32, and inferior-surface-of-tongue 33a of the guide pin holddown member 33, and is fixed. And the both-ends side of the optical waveguide substrate 32, each both-ends side of optical waveguide 31, and the both-ends side of the guide pin holddown member 33 are made flat-tapped, respectively.

[0032] The guide pin 23 in <u>drawing 9</u> is pinched into the guide slot 36, adhesion immobilization is carried out, only the inside of the space in the space by the side of the inferior surface of tongue of the guide pin 23 of the guide slot 36 and by the side of the contact to the guide pin holddown member 33 and the optical waveguide substrate 32 is filled up with adhesives 35, and is carrying out adhesion immobilization, and since <u>drawing 10</u> does not affect optical waveguide 31, it avoids restoration of adhesives 35, and it forms space between the up datum level 38 of optical waveguide 31, and the guide pin holddown member 33.

[0033] The optical waveguide substrate 32 and guide pin holddown-member 33 grade can carry out V groove formation of the guide slot 36 grade for positioning with the anisotropic etching technique of silicon, using single crystal silicon as a substrate ingredient. Moreover, on a silicon substrate, the quartz waveguide by the fire depositing method which can be constituted can be used easily, and it is formed with high precision.

[0034] The optical waveguide 31 of the optical waveguide substrate 32 and the optical fiber 11 of a multi-core photoconnector (8MT) 18 which were shown in <u>drawing 10</u> have consistency

correctly with a guide pin 23, and each adjustment end-face comrade is contacted. Thereby, optical waveguide 31 and an optical fiber 11 are correctly joined by no aligning.

[0035] [Example 5] <u>Drawing 11</u> is the 5th example of this invention, the perspective view of the joint of the waveguide type light coupler module 22 is shown, and <u>drawing 12</u> is drawing showing the side elevation of the waveguide type light coupler module 22.

[0036] The same sign is attached about the parts of a thing and coincidence explained in <u>drawing 6</u> of said 4th example - <u>drawing 10</u> in <u>drawing 11</u> and <u>drawing 12</u>, and explanation of an equivalent part is omitted.

[0037] As the waveguide type light coupler module concerning the 5th example is shown in drawing 11 and 12, in case optical waveguide 31 and the optical fiber 11 of a multi-core photoconnector (8MT) 18 are adjusted with a guide pin 23, end-face 18a of the multi-core photoconnector 18 which the optical fiber 11 of the multi-core photoconnector (8MT) 18 contacted exposes, and optical ON outgoing radiation end-face 22a of optical waveguide 31 are aslant ground at the respectively equal include angle theta. The 5th example is for reducing the reflective return light by the Fresnel reflection produced in a part for the joint of the optical waveguide 31 of said 4th example, and the optical fiber 11 of a multi-core photoconnector (8MT) 18. For example, it prevents the reflected light by Fresnel reflection becoming trapped mode by performing highly precise angle lapping at the include angle theta of about 8 times or more about end-face 18a of the multi-core photoconnector 18 which 11 of an optical fiber exposes, and optical ON outgoing radiation end-face 22a of optical waveguide 31, and reduction of connection loss of the propagation light by Fresnel reflection can be aimed at. [0038] [Example 6] Drawing 13 is the 6th example of this invention, the end view showing the relation between the optical waveguide substrate 32 and the guide pin holddown member 33 is shown, and drawing 14 is drawing showing the fitting condition of drawing 13. [0039] The cross-section configuration is formed in a reverse concave so that the guide pin holddown member 33 may enclose the top face and both-sides side of the optical waveguide substrate 32, as shown in drawing 13 and 14, and the waveguide type light coupler module concerning the 6th example is pinched for a guide pin 23 like said 4th example. [0040] Since the limit is added to the magnitude of optical ON outgoing radiation end-face 22a in the 6th example as shown in drawing 13, the both-sides sides 32a and 32b of the optical waveguide substrate 32 have been deleted to this side of the guide slot 36, and it is the width of face D1 between 32b from side-face 32a. Inferior-surface-of-tongue 33a of the guide pin holddown member 33 is set up equally (D=D1) so that it may oppose. Moreover, the depth H1 by which inferior-surface-of-tongue 33a which opposes the optical waveguide substrate 32 was used as the concave streak Height H of the top-most vertices of a guide pin 23 is set up equally (H=H1) from inferior-surface-of-tongue 32c of the optical waveguide substrate 32. A guide pin 23 is pinched by the peripheral surface of the guide slot 36 of the optical waveguide substrate 32, and inferior-surface-of-tongue 33a of the guide pin holddown member 33, and adhesion immobilization is carried out with adhesives 35 in the both-sides sides 32a and 32b of the optical waveguide substrate 32.

[0041] The 6th example can perform immobilization of the guide pin 23 which has reinforcement more in immobilization of the guide pin 23 of said 4th example. Moreover, also in adhesion with the optical waveguide substrate 32 and the guide pin holddown member 33, there is outstanding effectiveness from which reinforcement adhesion immobilization is attained and the desorption to the guide slot 36 of a guide pin 23 also becomes possible.

[0042] [Example 7] <u>Drawing 15</u> is the 7th example and is drawing showing the prototype configuration of the optical branching unit of this invention.

[0043] The 7th example made the optical branching unit as an experiment, as shown in drawing

15, and it was able to attain simplification of an optical branching unit. As shown in this drawing, the extra length processing section is expressed with the wavy line, and a thing without the complexity by tape-izing is checked. Moreover, by standing the waveguide type light coupler module 22 sideways, and mounting it in a unit, there is neither torsion in the extra length processing section of the tape core wire 19 nor a strain, and attachment of the tape core wire 19 can be performed.

[0044] The measurement result of a prototype is shown in "Table 1." It is the result of carrying out about the waveguide type light coupler module 22 in this prototype using a straight-line

waveguide type light module.

[0045]

[Table 1] 測定結果一覧表

心	線 Na	# 1	# 2	# 3	# 4	# 5	# 6	# 7	# 8
接紛	接続損失(dB)		0.87	0.72	0.77	0. 61	0.60	0.57	0.80
反射流	反射減衰量(dB)		46	52	47	51	47	52	47
温度	MAX値(dB)	0.16	0. 13	0.10	0. 15	0. 07	0.04	0.05	0.06
サイクル	MIN値(dB)	-0.14	-0.05	-0.07	-0.16	-0.03	-0.02	-0.04	-0.03
特性	変動量(dB)	0.30	0.18	0.17	0.31	0.10	0.06	0.09	0.09
ļ	偏光Loss特性(dB)		0.11	0.14	0.12	0.10	0. 05	0.10	0.07

[0046] Although the above 4th - the 6th example showed the case of the guide pin method which formed the guide slot 36 for positioning in one to the optical waveguide substrate 32, this invention may not be restricted to this, and may form other configurations, optical waveguide, and the guide slot for positioning in each **, for example, may fix them correctly by position relation, respectively. Moreover, although the case where eight optical waveguides 31 were formed in the above-mentioned example was shown, this invention is not restricted to this, and even if it uses the case where many optical waveguides and optical fibers are joined, the effectiveness of this invention can be acquired. Moreover, various structures can be considered that optical branching is just performed as this optical coupler.

[Effect of the Invention] Since simplification of a configuration and simplification of assembly can be attained by attaining formation of an integration chip, and tape-ization in this invention as explained above, a small and economical thing is obtained in the optical access part in a beamof-light way. Moreover, according to the waveguide type light coupler module of this invention, optical waveguide and an optical fiber were not aligned, and it becomes possible to carry out optical coupling very easily, it becomes possible to make connection between optical waveguide and an optical fiber by multi-core package, working capacity improves sharply, and reduction of cost is achieved. Moreover, there is outstanding effectiveness that it is simple for the configuration of each part article for the desorption of optical waveguide and an optical fiber to

become possible, and for changing of an optical waveguide chip etc. to be performed easily, and for transmission loss of a connection to be made small etc., for connection with a guide pin and a clip.

JPO and NCIPI are not responsible for any damages caused by the use of this translation.

- 1. This document has been translated by computer. So the translation may not reflect the original precisely.
- 2.**** shows the word which can not be translated.
- 3.In the drawings, any words are not translated.

TECHNICAL FIELD

[Industrial Application] This invention is used for the optical line access equipment in the optical-communication field, adds an optical insertion branching function to a beam-of-light way, and relates to the waveguide type light coupler module used for the optical branching unit which made a trial or monitor of a circuit possible, and this unit.

JPO and NCIPI are not responsible for any damages caused by the use of this translation.

- 1. This document has been translated by computer. So the translation may not reflect the original precisely.
- 2.**** shows the word which can not be translated.
- 3.In the drawings, any words are not translated.

PRIOR ART

[Description of the Prior Art] Being in a beam-of-light way trial system, the thing of the former (JP,2-1632,A) makes the optical branching unit 5 intervene between the optical fibers 11 for a communication link which they are between the fiber optic cable 9 for offices, and the fiber optic cable 10 for the outsides, as shown in drawing 16, equips this optical branching unit 5 with the communication link ports 1 and 2 and the trial ports 3 and 4, and is performing optical insertion and optical branching in these trial ports 3 and 4. The 1xN optical switch 13 for trial core-wire selection is connected to the trial ports 3 and 4, and it has the light pulse tester 14 which measures loss, the fault point, etc. of an optical fiber 11 further, the control unit 15, and the display 16 of a test result. Moreover, the optical filter 17 for trial light removal is arranged at the optical fiber 11 by the side of the optical transmission terminal office 12.

[0003] If it is in this system, in a trial, first, blank test core wire is chosen among N books with the 1xN optical switch 13, and the trial port 3 of the optical branching unit 5 in the selected core wire is chosen. And the trial light of the light pulse tester 14 is inserted in the fiber optic cable 10 for the outsides through the optical branching unit 5, and can measure loss, the fault point location, etc. of the optical fiber 11 for a communication link by receiving the level of the back scattered light.

[0004] The fiber optic cables 9 and 10 shown by this drawing 16 have held the optical fiber of dozens of or more alignments, as for the outside cable 10, a multi-core form optical fiber is used, and, as for the office cable 9, the single alignment type optical fiber is used, respectively. It will usually be called MDF (the main wiring rack) to carry out termination of the outside cable 10, and to connect with an office cable 9, and an optical branching unit will be held into this MDF. [0005] Drawing 17 is what showed an example (JP,2-258408,U) of the conventional optical branching unit. The optical fibers 1f and 2f of the port for a communication link corresponding to the communication link ports 1 and 2 and the trial ports 3 and 4 of the optical branching unit 5 which are shown in drawing 16, 3f of optical fibers of the port 3 for optical insertion, and 4f of optical fibers of the port 4 for optical branching are connected to the optical coupler unit 7 according to an individual, respectively. While 2f of optical fibers is connected to the single alignment ferrule 6, respectively, optical fibers 1f and 3f etc. show the optical branching unit 5 connected to the multi-core ferrule 8.

[0006] Drawing 18 shows an example (JP,4-340507,A) of the optical waveguide components in connection between the conventional optical fiber and optical waveguide. As shown in this drawing, as for the optical waveguide components 27, optical waveguide 31 is formed on the optical waveguide substrate 28 with which optical waveguide 31 was formed and guide 28b for positioning was formed. On the other hand, compare with this optical waveguide substrate 28, and it is contacted and the optical fiber alignment substrate 29 with which guide 29d for carrying out positioning with optical fiber alignment slot 29b which positions the optical fiber 11 which should be joined to optical waveguide 31, and said optical waveguide substrate 28 was formed is used. Optical waveguide components are constituted using the fixed substrate 30 with which guide carrier 30c which it fits in [c] with each guides 28b and 29d of said optical waveguide substrate 28 and the optical fiber alignment substrate 29, and adjusts said optical waveguide 31 and optical fiber 11 was formed.

JPO and NCIPI are not responsible for any damages caused by the use of this translation.

- 1. This document has been translated by computer. So the translation may not reflect the original precisely.
- 2.**** shows the word which can not be translated.
- 3.In the drawings, any words are not translated.

EFFECT OF THE INVENTION

[Effect of the Invention] Since simplification of a configuration and simplification of assembly can be attained by attaining formation of an integration chip, and tape-ization in this invention as explained above, a small and economical thing is obtained in the optical access part in a beam-of-light way. Moreover, according to the waveguide type light coupler module of this invention, optical waveguide and an optical fiber were not aligned, and it becomes possible to carry out optical coupling very easily, it becomes possible to make connection between optical waveguide and an optical fiber by multi-core package, working capacity improves sharply, and reduction of cost is achieved. Moreover, there is outstanding effectiveness that it is simple for the configuration of each part article for the desorption of optical waveguide and an optical fiber to become possible, and for changing of an optical waveguide chip etc. to be performed easily, and for transmission loss of a connection to be made small etc., for connection with a guide pin and a clip.

JPO and NCIPI are not responsible for any damages caused by the use of this translation.

- 1. This document has been translated by computer. So the translation may not reflect the original precisely.
- 2.**** shows the word which can not be translated.
- 3.In the drawings, any words are not translated.

TECHNICAL PROBLEM

[Problem(s) to be Solved by the Invention] by the way, in the optical branching unit since each above-mentioned **, each optical coupler which constitutes 2 sets of optical coupler units 7 from drawing 17 is a several mm cylindrical shape member in practice, and since the branching unit of further multi-core is formed not only in four alignments or eight alignments but in recently like drawing 17, equipment is becoming large-sized. Moreover, since optical fibers 1f, 2f, 3f, and 4f are connected to each optical coupler according to an individual, there are many production processes, and such a very troublesome process is needed that it becomes multi-core. [0008] Moreover, in connection with the conventional optical fiber and optical waveguide which were shown in drawing 18, if the optical waveguide 31 of the optical waveguide substrate 28 is not contacted at the same time it holds an optical fiber 11 in optical fiber alignment slot 29b of the optical fiber alignment substrate 29, there is a problem that immobilization is impossible with the fixed substrate 30. And there is a possibility that an optical fiber 11 may shift in the dielength direction delicately, in that case. Furthermore, there is a problem that attachment by the optical fiber alignment substrate 29 becomes difficulty, so that an optical fiber 11 becomes multi-core.

[0009] This invention aims at offering the waveguide type light coupler module used for the optical branching unit which simplified connection of an optical fiber, and this optical branching unit while it miniaturizes an optical coupler and summarizes extra length processing small in view of said problem.

JPO and NCIPI are not responsible for any damages caused by the use of this translation.

- 1. This document has been translated by computer. So the translation may not reflect the original precisely.
- 2.**** shows the word which can not be translated.
- 3.In the drawings, any words are not translated.

MEANS

[Means for Solving the Problem] The configuration of the optical branching unit concerning this invention which attains the above-mentioned purpose When performing a beam-of-light way trial, it can connect with the multi-core connector module of two 2-N alignment hold in the optical branching unit used for the optical line access equipment for inserting trial light in a beam-of-light way. N alignment hold form multi-core connector which hits one communication link port while it has the chip-ized waveguide form light coupler module which carried out N individual accumulation, It has 2-N alignment hold form multi-core connector which hits two trial ports, and N alignment multi-core connector which hits the communication link port of another side corresponding to above-mentioned one communication link port. While held N alignment corresponding to one trial port by turns with tape core wire among the abovementioned N alignment hold form multi-core connector and the above-mentioned 2-N alignment hold form multi-core connector, and it connects with the multi-core connector module of the above-mentioned 2-N alignment hold. It is based on having connected the remaining N alignment corresponding to the trial port of another side to the multi-core connector module of the above-mentioned 2-N alignment hold of another side held by turns with tape core wire among the above-mentioned N ***** optical connecter and the above-mentioned 2-N alignment hold form multi-core connector.

[0011] Moreover, the configuration of the waveguide type light coupler module used for the optical branching unit concerning this invention SiO2 formed on the silicon substrate The optical waveguide substrate which has the guide slot for positioning of at least two or more which has a predetermined distance and was formed in parallel from the optical waveguide and this optical waveguide which were formed corresponding to two or more optical fibers which have and install predetermined spacing on a layer, The guide pin holddown member which have [holddown member] the guide pin which fits into said guide slot, and these two or more guide pins make said guide Mizouchi project [holddown member] from the both-ends side of an optical waveguide substrate, and carries out adhesion immobilization, It is characterized by having a clip holding the optical coupling condition of the multi-core photoconnector which holds the optical fiber by which the position arrangement was carried out to comparing and carrying out optical coupling to said optical waveguide when said guide pin fits into said guide slot, and said optical waveguide and multi-core photoconnector.

[0012] The height of the each shaft center of optical waveguide and each shaft center of a guide pin in the both-ends side of an optical waveguide substrate is in agreement, and you may make it arrange on the same straight line in said waveguide type light coupler module.

[0013] You may make it prepare space between the up datum level of optical waveguide, and a guide pin holddown member in the optical waveguide substrate of said waveguide type light

coupler module.

[0014] You may make it grind aslant the end face of an optical fiber, and the optical ON outgoing radiation end face of optical waveguide at the respectively equal include angle theta in the optical waveguide substrate of said waveguide type light coupler module.
[0015] On the communication line of a waveguide type light coupler module, it may be made to mount the optical filter for trial light removal.

JPO and NCIPI are not responsible for any damages caused by the use of this translation.

- 1. This document has been translated by computer. So the translation may not reflect the original precisely.
- 2.**** shows the word which can not be translated.
- 3.In the drawings, any words are not translated.

OPERATION

[Function] Moreover, a miniaturization and extra length processing of an optical coupler could be simplified by tying with tape core wire between connectors by having the chip-ized optical coupler module and connecting with a connector, without using the conventional ****** coupler unit, and the production process also became very easy by integration and tape-ization.

[0017] Said waveguide type light coupler module fits in and positions a guide pin into the guide slot for positioning formed in the optical waveguide substrate, and makes this guide pin project from the both-ends side of the optical waveguide substrate concerned, and carries out adhesion immobilization by the guide pin holddown member. Subsequently, fitting is carried out with this guide pin in which this optical waveguide substrate and multi-core photoconnector were formed by this optical waveguide substrate. The optical waveguide by which this guide pin was prepared in the optical waveguide substrate in the condition of having fitted into the optical waveguide substrate and the multi-core photoconnector, and the multi-core photoconnector held at the multi-core photoconnector are adjusted, and an optical coupling condition is held with a clip. It enables this to join multi-core optical waveguide and optical fiber by no aligning.

JPO and NCIPI are not responsible for any damages caused by the use of this translation.

- 1. This document has been translated by computer. So the translation may not reflect the original precisely.
- 2.**** shows the word which can not be translated.
- 3.In the drawings, any words are not translated.

EXAMPLE

[Example] Hereafter, the example of this invention is explained with reference to drawing 1 drawing 15.

[0019] It explains referring to the example of point ** and the optical branching unit of this

invention about drawing 1 - drawing 5.

[0020] [Example 1] The multi-core connector of 4 alignment hold to which <u>drawing 1</u> is the optical branching unit of the 1st example, and 18A hits a communication link port, The multi-core connector of 8 alignment hold to which 18B hits a trial port, the multi-core connector module of 8 alignment hold connected to the waveguide type light coupler module 22 with which 18C and 18D allotted the optical coupler unit 7, It is a pin for connection for the single alignment connector to which 19 hits 4 alignment tape core wire, and 20 hits a communication link port, and 21 to align an extra length tray, and for 23 align the optical coupler module 22 and the multi-core connector modules 18C and 18D. In here, the waveguide type light coupler module 22 is the chip by which four alignments were integrated, and can connect now the multi-core connector modules 18C and 18D to this module 22.

[0021] $\underline{\text{Drawing 2}}$ shows drawing which connected the optical coupler module 22 and the connector modules 18C and 18D which are shown in $\underline{\text{drawing 1}}$, and the optical branching unit 5

completed as a whole.

[0022] [Example 2] <u>Drawing 3</u> is the optical branching unit of the 2nd example, and it gives an include angle suitably so that the optical filter 17 for trial light removal may be inserted into the communication line of the waveguide type light coupler module 22 and the difference with <u>drawing 1</u> may moreover prevent reflection to the communication line. And the hole 24 for insertion of this optical filter 17 is made by etching etc. Simplification and economization of a system can be attained by existence of this filter 17.

[0023] [Example 3] <u>Drawing 4</u> is the optical branching unit of the 3rd example, and the filter base plate 25 with which the waveguide type light coupler module 22 is equipped is equipped with an optical filter 17 according to the array of the communication line. And in order to prevent reflection to the communication line like the case of <u>drawing 3</u>, it is inserted in the slot 26 which gave the suitable include angle, and is fixed with adhesives. the filter base plate 25 and a filter 17 are shown in <u>drawing 5</u> (a) and (b) -- as -- the shape of a ****** rectangle -- or it may be constituted so that it may become a bridge beam configuration. In this case, as compared with the structure shown in <u>drawing 3</u>, it was not based on etching, but the usual cutting was completed, and creation of the waveguide type light coupler module 22 became easy. [0024] In the optical branching unit mentioned above, although the explanation about the interior of an optical coupler module is omitted, it is not limited to the example shown below that optical branching is just performed as this optical coupler, but various structures can be considered.

[0025] Next, it explains, using for the optical branching unit of this invention, and referring to drawing 6 - drawing 15 about the example of a suitable waveguide type light coupler module. [0026] [Example 4] Drawing 6 is the 4th example of this invention, and the waveguide type light coupler module 22 is constituted by the optical waveguide substrate 32, the guide pin holddown member 33, the multi-core photoconnector (8MT) 18, the clip 34, and the guide pin 23, and is drawing having shown the junction condition of optical waveguide and an optical fiber. [0027] Drawing 7 is the exploded view of drawing 6, where optical waveguide 31 and the guide slot 36 for positioning were established in the optical waveguide substrate 32, and it fitted in and positioned the guide pin 23 to it in this guide slot 36 and some guide pins 23 are made to project from the both-ends side of the optical waveguide substrate 32, adhesion immobilization is carried out by the guide pin holddown member 33 with adhesives 35, and this guide pin 23 is held at the optical waveguide substrate 32. The multi-core photoconnector (8MT) 18 holds the optical fiber 11 by which the position arrangement was carried out to comparing and carrying out optical coupling to said optical waveguide 31, when said guide pin 23 fits into said guide slot 36, and it becomes joinable by being compared in the guide pin hole 37 of this multi-core photoconnector (8MT) 18. A clip 34 holds the optical coupling condition of said optical waveguide 31 and multi-core photoconnector (8MT) 18.

[0028] The multi-core photoconnector (8MT) 18 shown in <u>drawing 7</u> is a fracture perspective view a part, and <u>drawing 8</u> inserts in the ferrule of a multi-core photoconnector two 4 alignment tape core wire 19 which hits a communication link port and a trial port. Each core wire of two 4 alignment tape core wire 19 and 19 is connected with the waveguide type light coupler module 22 which is held by turns and counters here.

[0029] It is SiO2 by which drawing 9 is the end view showing the relative-position relation between optical waveguide 31 and a guide pin 23, and the optical waveguide substrate 32 was formed on the silicon substrate. The guide slot 36 for positioning of at least two or more which has the predetermined distance W and was formed in parallel from the optical waveguide 31 and this optical waveguide 31 which were formed corresponding to two or more optical fibers 11 which have and install predetermined spacing on a layer is formed. Moreover, the guide pin holddown member 33 fixes the guide pin 23 which fits into said guide slot 36, and after these two or more guide pins 23 have made it project from the both-ends side of said guide slot 36 intrinsic-light waveguide substrate 32, it is carrying out adhesion immobilization. [0030] As for the optical waveguide 31 formed in the optical waveguide substrate 32 in the end face of the optical waveguide substrate 32, eight optical waveguides 31 are formed by two or more, for example, this example, the location of depth h predetermined [the datum level / shaft center / each / 38 on the basis of the top face of the optical waveguide substrate 32 as such optical waveguides 31 are shown in drawing 9 to] -- and spacing PF predetermined in each shaft center distance It is prepared side by side. The guide slot 36 for positioning in moreover, the location of the predetermined distance W from the shaft center of the optical waveguide 31 of both ends And it is set up and formed so that the depth of the shaft center of a guide pin 23 may be in agreement with the depth of said optical waveguide 31. Each spacing PF of two or more optical fibers 11 which the guide pin 23 connected behind and the multi-core photoconnector (8MT) 18 which has the guide pin hole 37 which fits in hold And spacing PG of the guide pin hole 37 A relative position is made to agree, respectively and it is arranged on the same straight

[0031] On the other hand, the optical waveguide substrate 32 and inferior-surface-of-tongue 33a which counters form the crevice, and the guide pin holddown member 33 is the height h1 of the top-most vertices of a guide pin 23 from the datum level 38 of depth d and the optical waveguide substrate 32. It is set up equally (d=h1). And a guide pin 23 is pinched by the peripheral surface

of the guide slot 36 of the optical waveguide substrate 32, and inferior-surface-of-tongue 33a of the guide pin holddown member 33, and is fixed. And the both-ends side of the optical waveguide substrate 32, each both-ends side of optical waveguide 31, and the both-ends side of the guide pin holddown member 33 are made flat-tapped, respectively.

[0032] The guide pin 23 in <u>drawing 9</u> is pinched into the guide slot 36, adhesion immobilization is carried out, only the inside of the space in the space by the side of the inferior surface of tongue of the guide pin 23 of the guide slot 36 and by the side of the contact to the guide pin holddown member 33 and the optical waveguide substrate 32 is filled up with adhesives 35, and is carrying out adhesion immobilization, and since <u>drawing 10</u> does not affect optical waveguide 31, it avoids restoration of adhesives 35, and it forms space between the up datum level 38 of optical waveguide 31, and the guide pin holddown member 33.

[0033] The optical waveguide substrate 32 and guide pin holddown-member 33 grade can carry out V groove formation of the guide slot 36 grade for positioning with the anisotropic etching technique of silicon, using single crystal silicon as a substrate ingredient. Moreover, on a silicon substrate, the quartz waveguide by the fire depositing method which can be constituted can be used easily, and it is formed with high precision.

[0034] The optical waveguide 31 of the optical waveguide substrate 32 and the optical fiber 11 of a multi-core photoconnector (8MT) 18 which were shown in <u>drawing 10</u> have consistency correctly with a guide pin 23, and each adjustment end-face comrade is contacted. Thereby, optical waveguide 31 and an optical fiber 11 are correctly joined by no aligning.

[0035] [Example 5] <u>Drawing 11</u> is the 5th example of this invention, the perspective view of the

[0035] [Example 5] <u>Drawing 11</u> is the 5th example of this invention, the perspective view of the joint of the waveguide type light coupler module 22 is shown, and <u>drawing 12</u> is drawing showing the side elevation of the waveguide type light coupler module 22.

[0036] The same sign is attached about the parts of a thing and coincidence explained in <u>drawing 6</u> of said 4th example - <u>drawing 10</u> in <u>drawing 11</u> and <u>drawing 12</u>, and explanation of an equivalent part is omitted.

[0037] As the waveguide type light coupler module concerning the 5th example is shown in drawing 11 and 12, in case optical waveguide 31 and the optical fiber 11 of a multi-core photoconnector (8MT) 18 are adjusted with a guide pin 23, end-face 18a of the multi-core photoconnector 18 which the optical fiber 11 of the multi-core photoconnector (8MT) 18 contacted exposes, and optical ON outgoing radiation end-face 22a of optical waveguide 31 are aslant ground at the respectively equal include angle theta. The 5th example is for reducing the reflective return light by the Fresnel reflection produced in a part for the joint of the optical waveguide 31 of said 4th example, and the optical fiber 11 of a multi-core photoconnector (8MT) 18. For example, it prevents the reflected light by Fresnel reflection becoming trapped mode by performing highly precise angle lapping at the include angle theta of about 8 times or more about end-face 18a of the multi-core photoconnector 18 which 11 of an optical fiber exposes, and optical ON outgoing radiation end-face 22a of optical waveguide 31, and reduction of connection loss of the propagation light by Fresnel reflection can be aimed at: [0038] [Example 6] Drawing 13 is the 6th example of this invention, the end view showing the relation between the optical waveguide substrate 32 and the guide pin holddown member 33 is shown, and drawing 14 is drawing showing the fitting condition of drawing 13. [0039] The cross-section configuration is formed in a reverse concave so that the guide pin holddown member 33 may enclose the top face and both-sides side of the optical waveguide substrate 32, as shown in drawing 13 and 14, and the waveguide type light coupler module concerning the 6th example is pinched for a guide pin 23 like said 4th example. [0040] Since the limit is added to the magnitude of optical ON outgoing radiation end-face 22a in the 6th example as shown in drawing 13, the both-sides sides 32a and 32b of the optical

waveguide substrate 32 have been deleted to this side of the guide slot 36, and it is the width of face D1 between 32b from side-face 32a. Inferior-surface-of-tongue 33a of the guide pin holddown member 33 is set up equally (D=D1) so that it may oppose. Moreover, the depth H1 by which inferior-surface-of-tongue 33a which opposes the optical waveguide substrate 32 was used as the concave streak Height H of the top-most vertices of a guide pin 23 is set up equally (H=H1) from inferior-surface-of-tongue 32c of the optical waveguide substrate 32. A guide pin 23 is pinched by the peripheral surface of the guide slot 36 of the optical waveguide substrate 32, and inferior-surface-of-tongue 33a of the guide pin holddown member 33, and adhesion immobilization is carried out with adhesives 35 in the both-sides sides 32a and 32b of the optical waveguide substrate 32.

[0041] The 6th example can perform immobilization of the guide pin 23 which has reinforcement more in immobilization of the guide pin 23 of said 4th example. Moreover, also in adhesion with the optical waveguide substrate 32 and the guide pin holddown member 33, there is outstanding effectiveness from which reinforcement adhesion immobilization is attained and the desorption to the guide slot 36 of a guide pin 23 also becomes possible.

[0042] [Example 7] <u>Drawing 15</u> is the 7th example and is drawing showing the prototype configuration of the optical branching unit of this invention.

[0043] The 7th example made the optical branching unit as an experiment, as shown in <u>drawing</u> 15, and it was able to attain simplification of an optical branching unit. As shown in this drawing, the extra length processing section is expressed with the wavy line, and a thing without the complexity by tape-izing is checked. Moreover, by standing the waveguide type light coupler module 22 sideways, and mounting it in a unit, there is neither torsion in the extra length processing section of the tape core wire 19 nor a strain, and attachment of the tape core wire 19 can be performed.

[0044] The measurement result of a prototype is shown in "Table 1." It is the result of carrying out about the waveguide type light coupler module 22 in this prototype using a straight-line waveguide type light module.

[0045]

[Table 1]

測定結果一覧表

心	線 No.	# 1	# 2	# 3	# 4	# 5	# 6	# 7	# 8
接続損失(dB)		0. 69	0.87	0.72	0. 77	0. 61	0. 60	0. 57	0.80
反射減衰量(dB)		49	46	52	47	51	47	52	47
温度	MAX値(dB)	0. 16	0. 13	0.10	0. 15	0. 07	0. 04	0.05	0.06
サイクル	MIN値(dB)	-0.14	-0.05	-0.07	-0.16	-0.03	-0. 02	-0.04	-0.08
特性	変動量(dB)	0. 30	0.18	0. 17	0. 31	0. 10	0. 06	0.09	0.09
偏光Loss特性(dB)		0. 09	0.11	0. 14	0.12	0. 10	0. 05	0.10	0.07

[0046] Although the above 4th - the 6th example showed the case of the guide pin method which

formed the guide slot 36 for positioning in one to the optical waveguide substrate 32, this invention may not be restricted to this, and may form other configurations, optical waveguide, and the guide slot for positioning in each **, for example, may fix them correctly by position relation, respectively. Moreover, although the case where eight optical waveguides 31 were formed in the above-mentioned example was shown, this invention is not restricted to this, and even if it uses the case where many optical waveguides and optical fibers are joined, the effectiveness of this invention can be acquired. Moreover, various structures can be considered that optical branching is just performed as this optical coupler.